

BiCMOS 1A Current-Mode PWM Controllers

Features

- Fast 20 ns Output Rise and 15 ns Output Fall Times
- –40°C to +85°C Temperature Range Exceeds UC284x Specifications
- · High-Performance, Low-Power BiCMOS Process
- Ultra-Low Start-Up Current (50 µA Typical)
- · Low Operating Current (4 mA Typical)
- High Output Drive (1A Peak Current, HC Version)
- · CMOS Outputs with Rail-to-Rail Swing
- · Current-Mode Operation up to 500 kHz
- · Trimmed 5V Bandgap Reference
- Pin-for-Pin Compatible with UC3842/3843/3844/3845(A)
- · Trimmed Oscillator Discharge Current
- · UVLO with Hysteresis
- · Low Cross-Conduction Currents

Applications

- Current-Mode, Offline, Switched-Mode Power Supplies
- · Current-Mode, DC-to-DC Converters
- · Step-Down "Buck" Regulators
- · Step-Up "Boost" Regulators
- · Flyback, Isolated Regulators
- · Forward Converters
- Synchronous FET Converters

General Description

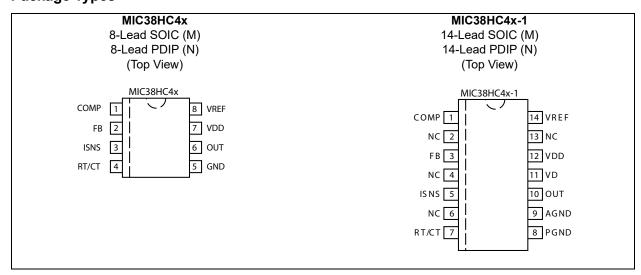
The MIC38HC4x family are fixed-frequency current-mode PWM controllers with 1A drive current capability. Microchip's BiCMOS devices are pin-compatible with 384x bipolar devices. Their high output drive, with fast rise and fall times, combined with low startup current make them ideal PWM controllers when high efficiency is required.

Undervoltage lockout circuitry allows the '42 and '44 versions to start up at 14.5V and operate down to 9V, and the '43 and '45 versions start at 8.4V with operation down to 7.6V. All versions operate up to 20V.

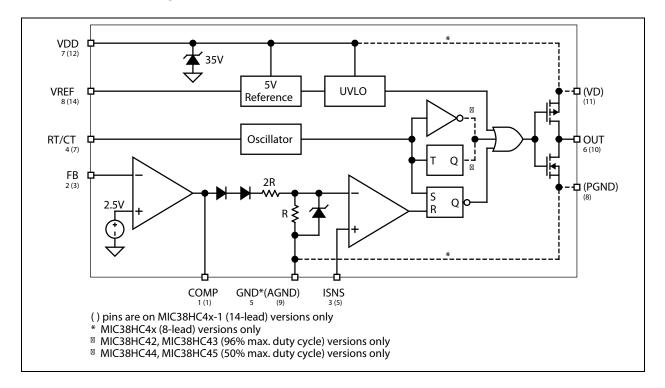
When compared to bipolar UC384x devices operating from a 15V supply, start-up current has been reduced to 50 μ A typical and operating current has been reduced to 4.0 mA typical. Decreased output rise and fall times drive larger MOSFETs, and rail-to-rail output capability increases efficiency, especially at lower supply voltages. The MIC38HC4x also features a trimmed oscillator discharge current and bandgap reference.

MIC38HC4x-1 is available in 14-lead plastic DIP and SOIC packages. 8-lead devices feature small size, while 14-lead devices separate the analog and power connections for improved performance and power dissipation.

Package Types



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Zener Current (V _{DD})	30 mA
Operation at ≥18V may require special precautions (Note 1).	
Supply Input Voltage (V _{DD}) (Note 1)	+20V
Switch Supply Voltage (V _D)	+20V
Current Sense Voltage (V _{ISNS})	
Feedback Voltage (V _{FB})	
Output Current (I _{OUT})	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: On 8-lead versions, 20V is the maximum input on Pin 7 because this is also the supply pin for the output stage. On 14-lead versions, 40V is the maximum for Pin 12 and 20V is the maximum for Pin 11.

ELECTRICAL CHARACTERISTICS

Electrical Characteristics: V_{DD} = 15V, Note 1; R_T = 9.09 k Ω ; C_T = 3.3 nF; $-40^{\circ}C \le T_A \le 85^{\circ}C$; unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Reference								
Output Voltage	V _{OUT}	4.90	5.00	5.10	V	T _A = 25°C, I _O = 1 mA		
Line Regulation	ΔV _{OUT} / V _{OUT}	_	2	20	mV	12V ≤ V _{DD} ≤ 18V, I _O = 5 μA, Note 2		
Load Regulation	$\Delta V_{OUT}/$ $(V_{OUT} x$ $\Delta V_{IN})$	_	1	25	mV	1 mA ≤ I _O ≤ 20 mA		
Temperature Stability	T _{STAB}	_	0.2	_	mV/°C	Note 3		
Total Output Variation		4.82	_	5.18	V	Line, Load, Temp., Note 3		
Output Noise Voltage		_	50	_	μV	10Hz ≤ f ≤ 10 kHz, T _A = 25°C, Note 3		
Long Term Stability		_	5	25	mV	T _A = 125°C, 1000 hrs., Note 3		
Output Short Circuit		-30	-80	-180	mA	_		
Oscillator								
Initial Accuracy		49	52	55	kHz	T _A = 25°C, Note 4		
Voltage Stability	V_{STAB}	_	0.2	1.0	%	12V ≤ V _{DD} ≤ 18V, Note 2		
Temperature Stability	T _{STAB}	_	0.04		%/°C	$T_{MIN} \le T_A \le T_{MAX}$, Note 3		
Clock Ramp Reset Current		7.7	8.4	9.0	mA	$T_A = 25$ °C, $V_{RT/CT} = 2V$		
Clock Ramp Reset Current	I _{CLK_RR}	7.2	8.4	9.5	ША	$T_A = T_{MIN}$ to T_{MAX}		
Amplitude		_	1.9		V_{PP}	V _{RT/CT} peak to peak		
Error Amp								
Input Voltage	V_{IN}	2.42	2.50	2.58	V	V _{COMP} = 2.5V		
Input Bias Current	I _{IN}	_	-0.1	-2	μA	V _{FB} = 5.0V		
Voltage Amplitude	A _{VOL}	65	90	_	dB	$2V \le V_O \le 4V$		
Unity Gain Bandwidth		0.7	1.0		MHz	Note 3		
Power Supply Rejection Ratio	PSRR	60	_	_	dB	12V ≤ V _{DD} ≤ 18V		
Output Sink Current	I _{SINK}	2	14		mA	V _{FB} = 2.7V, V _{COMP} = 1.1V		
Output Source Current	I _{SOURCE}	-0.5	-1	_	mA	V _{FB} = 2.3V, V _{COMP} = 5V		
Output Voltage High	V _{OH}	5	6.8	_	V	V_{FB} = 2.3V, R_L = 15 kΩ to Ground		

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics: V_{DD} = 15V, Note 1; R_T = 9.09 k Ω ; C_T = 3.3 nF; $-40^{\circ}C \le T_A \le 85^{\circ}C$; unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions		
Output Voltage Low	V _{OL}	_	0.1	1.1	V	V_{FB} = 2.7V, R_L = 15 k Ω to V_{REF}		
Current Sense								
Gain		2.85	3.0	3.15	V/V	Note 5, Note 6		
Maximum Threshold		0.9	1	1.1	V	V _{COMP} = 5V, Note 5		
Power Supply Rejection Ratio	PSRR		70		dB	12V ≤ V _{DD} ≤ 18V, Note 5		
Input Bias Current		_	-0.1	-2	μA	_		
Delay to Output Time	t _{D-O}	_	120	250	ns	_		
Output								
R _{DS(ON)} High		_	10		Ω	I _{SOURCE} = 200 mA		
R _{DS(ON)} Low			5.5		Ω	I _{SINK} = 200 mA		
Rise Time	t _R		20	50	ns	$T_A = 25^{\circ}C, C_L = 1 \text{ nF}$		
Fall Time	t _F	_	15	40	ns	$T_A = 25^{\circ}C, C_L = 1 \text{ nF}$		
Undervoltage Lockout	Undervoltage Lockout							
Start Threshold Voltage	V _{ST_TH}	13.5	14.5	15.5	V	MIC38HC42/4		
Start Theshold Voltage		7.8	8.4	9.0	V	MIC38HC43/5		
Minimum Operating Voltage	V	8	9	10	V	MIC38HC42/4		
Willimum Operating Voltage	V _{OP(MIN)}	7.0	7.6	8.2	V	MIC38HC43/5		
Pulse Width Modulator								
Maximum Duty Cycle	D	94	96	_	%	MIC38HC42/3		
Waximum Buty Cycle	D _{MAX}	46	50	_	70	MIC38HC44/5		
Minimum Duty Cycle	D _{MIN}	_		0	%	_		
Total Standby Current								
Chart I la Commant	1.	_	50	200	μA	V _{DD} = 13V, MIC38HC42/44		
Start-Up Current	I _{SU}	_	50	200	μΑ	V _{DD} = 7.5V, MIC38HC43/45		
Operating Supply Current		_	4.0	6.0	mA	$V_{FB} = V_{ISNS} = 0V$		
Zener Voltage	V_{DD}	30	37	_	V	I _{DD} = 25 mA, Note 2		

- **Note 1:** Adjust V_{DD} above the start threshold before setting at 15V.
 - 2: On 8-lead versions, 20V is the maximum input on Pin 7 because this is also the supply pin for the output stage. On 14-lead versions, 40V is the maximum for Pin 12 and 20V is the maximum for Pin 11.
 - **3:** These parameters, although ensured, are not 100% tested in production.
 - **4:** Output frequency equals oscillator frequency for the MIC38HC42 and MIC38HC43. Output frequency for the MIC38HC44 and MIC38HC45 equals one half the oscillator frequency.
 - **5:** Parameter measured at trip point of latch with $V_{EA} = 0V$.
 - **6:** Gain is defined as A = $\Delta V_{PIN1}/V_{TH} \times I_{SNS}$; 0 ≤ ($V_{TH} \times I_{SNS}$) ≤ 0.8V.

TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Maximum Junction Temperature	T _{J(MAX)}	_	_	+150	°C	_
Junction Temperature Range	T _J	-40	_	+85	°C	_
Storage Temperature	T _S	-65	_	+150	°C	_
Package Thermal Resistances						
Thermal Resistance, PDIP 8-Ld	$\theta_{\sf JA}$	_	125	_	°C/W	_
Thermal Resistance, SOIC 8-Ld	$\theta_{\sf JA}$	_	170	_	°C/W	_
Thermal Resistance, PDIP 14-Ld	$\theta_{\sf JA}$	_	90	_	°C/W	_
Thermal Resistance, SOIC 14-Ld	$\theta_{\sf JA}$	_	145	_	°C/W	_

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

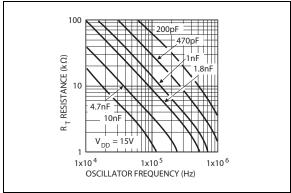


FIGURE 2-1: Oscillat Configuration.

Oscillator Frequency

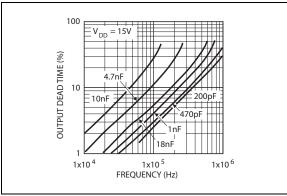


FIGURE 2-2: MIC38HC42/3 Output Dead Time vs. Oscillator Frequency.

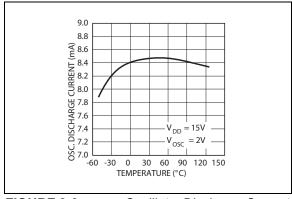


FIGURE 2-3: Oscillator Discharge Current vs. Temperature.

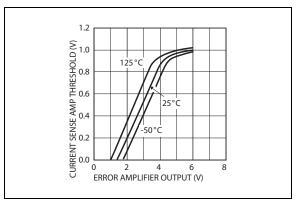


FIGURE 2-4: Current Sense Amplifier vs. Error Amplifier Output.

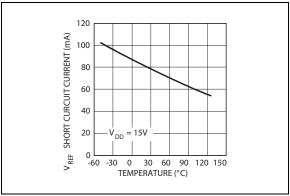


FIGURE 2-5: Short-Circuit Reference Current vs. Temperature.

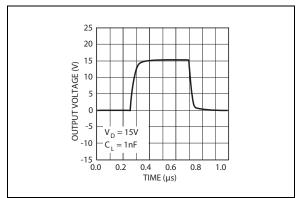


FIGURE 2-6: MIC38HC4x Output Waveform.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

Pin Number MIC38HC4x	Pin Number MIC38HC4x-1	Pin Name	Description		
1	1	COMP	Compensation: Connect external compensation network to modify the error amplifier output.		
_	2	NC	Not internally connected.		
2	3	FB	Feedback (Input): Error amplifier input. Feedback is 2.5V at desired output voltage.		
_	4	NC	Not internally connected.		
3	5	ISNS	Current Sense (Input): Current sense comparator input. Connect to current sensing resistor or current transformer.		
_	6	NC	Not internally connected.		
4	7	RT/CT	Timing Resistor/Timing Capacitor: Connect external RC network to select switching frequency.		
5	_	GND	Ground: Combined analog and power ground.		
_	8	PGND	Power Ground: N-channel driver transistor ground.		
_	9	AGND	Analog Ground: Controller circuitry ground.		
6	10	OUT	Power Output: Totem-pole output.		
_	11	VD	Power Supply (Input): P-channel driver transistor supply input. Return to power ground (PGND).		
7	12	VDD	Analog Supply (Input): Controller circuitry supply input. Return to analog ground (AGND).		
	13	NC	Not internally connected.		
8	14	VREF	5V Reference (Output): Connect external RC network.		

4.0 PACKAGING INFORMATION

4.1 **Package Marking Information**

WNNN

8-Lead SOIC* 8-Lead PDIP* Example Example MIC MIC T XXX MIC **M** XXX XXXXXXX 38HC42YM XXXXXXX 38HC44YN WNNN 96T6 **4S49** WNNN 14-Lead SOIC* Example 14-Lead PDIP* Example M XXX MIC MIC M XXX MIC MIC XXXXXX-XXX 38HC43-1YM XXXXXX-XXX 38HC45-1YN

WNNN

20B8

Legend: XX...X Product code or customer-specific information Υ Year code (last digit of calendar year) ΥY Year code (last 2 digits of calendar year) WW Week code (week of January 1 is week '01') Alphanumeric traceability code NNN Pb-free JEDEC® designator for Matte Tin (Sn) (e3) This package is Pb-free. The Pb-free JEDEC designator (@3) can be found on the outer packaging for this package. •, ▲, ▼ Pin one index is identified by a dot, delta up, or delta down (triangle mark). Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include

the corporate logo.

Underbar () symbol may not be to scale.

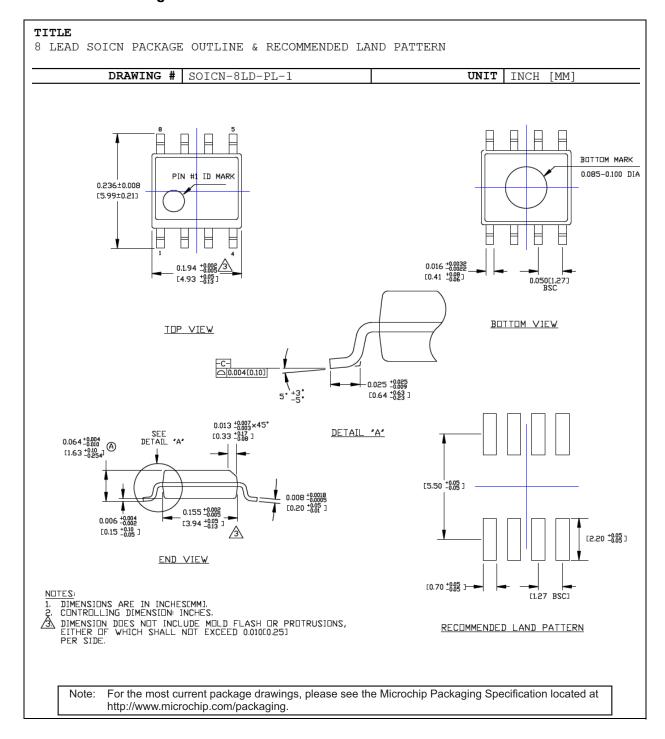
5K3I

Note: If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space:

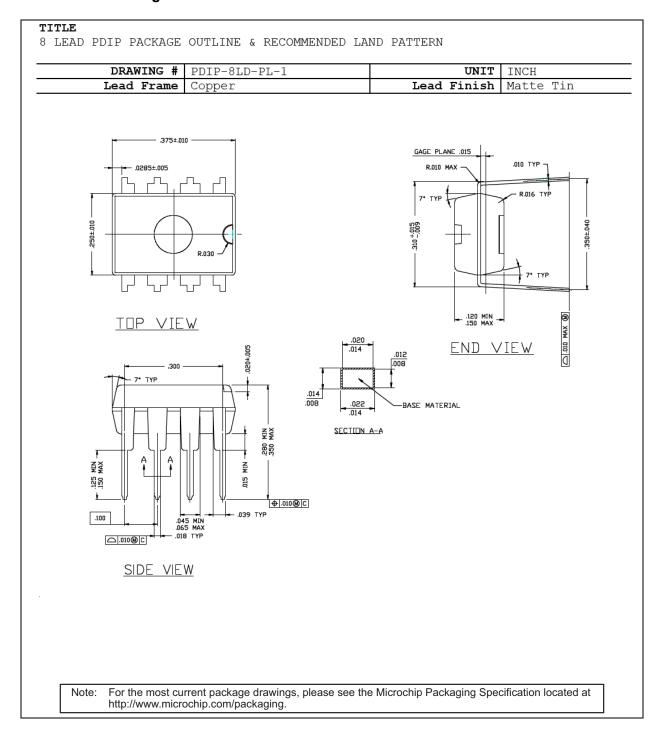
6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN;

2 Characters = NN; 1 Character = N

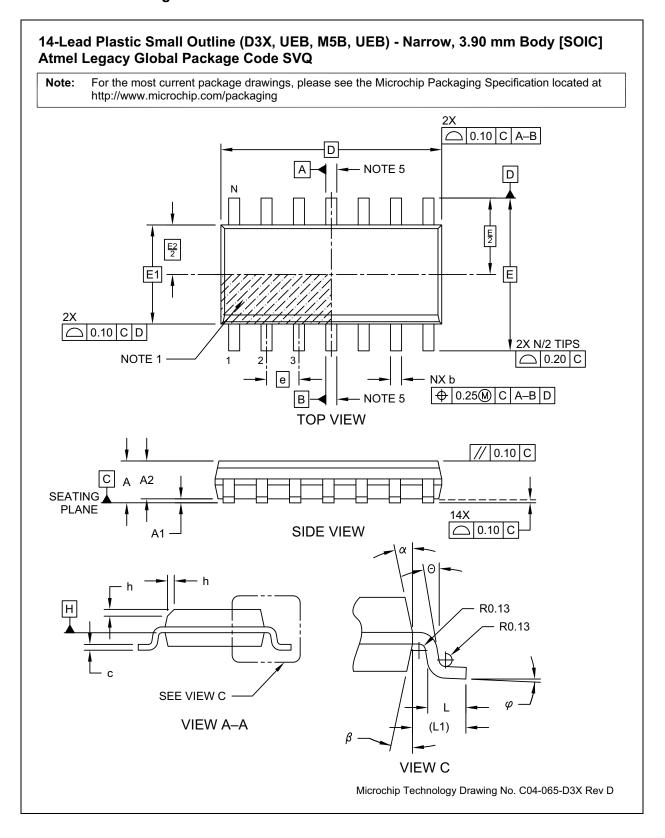
8-Lead SOIC Package Outline and Recommended Land Pattern



8-Lead PDIP Package Outline and Recommended Land Pattern

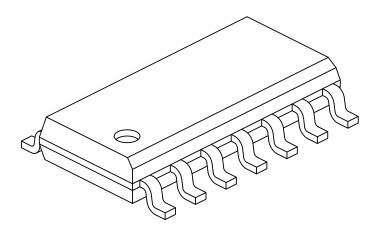


14-Lead SOIC Package Outline and Recommended Land Pattern



14-Lead Plastic Small Outline (D3X, UEB, M5B, UEB) - Narrow, 3.90 mm Body [SOIC] Atmel Legacy Global Package Code SVQ

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS				
Dimension	MIN	NOM	MAX		
Number of Pins	N		14		
Pitch	е		1.27 BSC		
Overall Height	Α	ı	-	1.75	
Molded Package Thickness	A2	1.25	-	-	
Standoff §	A1	0.10	-	0.25	
Overall Width	Е	6.00 BSC			
Molded Package Width	E1	3.90 BSC			
Overall Length	D	8.65 BSC			
Chamfer (Optional)	h	0.25 - 0.50			
Foot Length	L	0.40	-	1.27	
Footprint	L1	1.04 REF			
Lead Angle	Θ	0°	-	-	
Foot Angle	φ	0° - 8°			
Lead Thickness	С	0.10 - 0.25			
Lead Width	b	0.31	-	0.51	
Mold Draft Angle Top	α	5°	-	15°	
Mold Draft Angle Bottom	β	5°	-	15°	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M

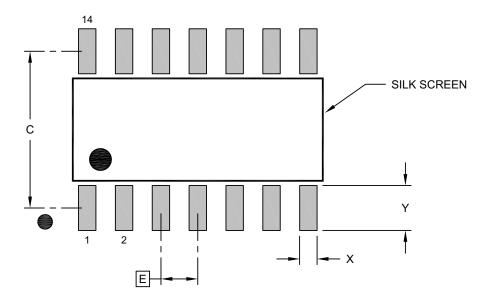
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-065-D3X Rev D Sheet 2 of 2

14-Lead Plastic Small Outline (D3X, UEB, M5B, UEB) - Narrow, 3.90 mm Body [SOIC] Atmel Legacy Global Package Code SVQ

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	Е		1.27 BSC	
Contact Pad Spacing	С		5.40	
Contact Pad Width (X14)	Х			0.60
Contact Pad Length (X14)	Υ			1.55

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2065-D3X Rev D

14-Lead PDIP Package Outline and Recommended Land Pattern

TITLE 14 LEAD PDIP PACKAGE OUTLINE & RECOMMENDED LAND PATTERN UNIT DRAWING # PDIP-14LD-PL-1 INCH LEAD FRAME LEAD FINISH Matte Tin Copper .060±.010 PIN#1 ø.080±.005 0.013DP MAX (3 PLACES) .005 MIN .130±.008 R.030 .015 GAGE PLANE 0.15 MM -C-MAX BASE MATERIAL 125 SECTION A-A .100 For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging.

APPENDIX A: REVISION HISTORY

Revision A (March 2023)

- Converted Micrel document MIC38HC42/3/4/5 to Microchip data sheet DS20006735A.
- Minor text changes throughout.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

Part Number	[- <u>X</u>]	<u>x</u>	<u>X</u>	[- <u>XX</u>]	Example	es:	
Device	Special Pack- age Option	Temp. Range	Package	Media Type	a) MIC38	HC42YM:	MIC38HC42 (see Selection Guide), -40°C to +85°C Temp. Range, 8-Lead SOIC, 95/Tube
Device:	MIC38HC4x:		IA Current-Mode For		b) MIC38	HC43-1YN:	MIC38HC43 (see Selection Guide), -40°C to +85°C Temp. Range, 14-Lead PDIP, 25/Tube
Special Package Option:	1 = 14-Lea	nd PDIP or SC	DIC		c) MIC38	HC44-1YM-TR:	MIC38HC44 (see Selection Guide), -40°C to +85°C Temp. Range, 14-Lead SOIC, 2,500/Reel
Temperature Range:	Y = -40)°C to +85°C			d) MIC38	HC45YN:	MIC38HC45 (see Selection Guide), -40°C to +85°C Temp. Range, 8-Lead PDIP, 50/Tube
Package:		ead or 14-Lea ead or 14-Lea			e) MIC38	HC42-1YN:	MIC38HC42 (see Selection Guide), -40°C to +85°C Temp. Range, 14-Lead PDIP, 25/Tube
Media Type:	 	Tube (8-Lead	id SOIC only) I PDIP only)		f) MIC38H	HC43YM-TR:	MIC38HC43 (see Selection Guide), -40°C to +85°C Temp. Range, 8-Lead SOIC, 2,500/Reel identifier only appears in the
	 				catalog part nu used for orderi the device pac	Imber description. This identifier is ng purposes and is not printed on kage. Check with your Microchip r package availability with the Tape	

Selection Guide

	UVLO Thresholds					
Duty Cycle	Startup 8.4V Minimum Operating 7.6V	Startup 14.5V Minimum Operating 9V				
0% to 96%	MIC38HC43	MIC38HC42				
0% to 50%	MIC38HC45	MIC38HC44				

NOTES:

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